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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09/681,304	03/15/2001	Richard Joseph Saia	RD-28435	9545
6147	7590 01/12/2004		EXAM	IINER
= :	LELECTRIC COMPA	NGUYEN, DILINH P		
GLOBAL RESEARCH CENTER PATENT DOCKET RM. 4A59 PO BOX 8, BLDG. K-1 ROSS NISKAYUNA, NY 12309			ART UNIT	PAPER NUMBER
			2814	
			DATE MAILED: 01/12/2004	

Please find below and/or attached an Office communication concerning this application or proceeding.

		952				
	Application No.	Applicant(s)				
Office Action Summany	09/681,304	SAIA ET AL.				
Office Action Summary	Examiner	Art Unit				
7/ 14411 010 0175 611	DiLinh Nguyen	2814				
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with	the correspondence address				
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period of the period of the period for reply within the set or extended period for reply will, by statute - Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).  Status	36(a). In no event, however, may a rep y within the statutory minimum of thirty ( will apply and will expire SIX (6) MONTH , cause the application to become ABA	ly be timely filed  30) days will be considered timely.  IS from the mailing date of this communication.  NDONED (35 U.S.C. § 133).				
1) Responsive to communication(s) filed on <u>05 I</u>	November 2003 .					
2a) ☐ This action is <b>FINAL</b> . 2b) ☐ Th	is action is non-final.					
3) Since this application is in condition for allows closed in accordance with the practice under Disposition of Claims						
4) Claim(s) 1-4,6-8,16 and 19 is/are pending in t	he application.					
4a) Of the above claim(s) is/are withdraw	wn from consideration.					
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>1-4,6-8 and 16</u> is/are rejected.						
7)⊠ Claim(s) <u>19</u> is/are objected to.						
8) Claim(s) are subject to restriction and/o	r election requirement.					
Application Papers						
9) The specification is objected to by the Examine						
10)☐ The drawing(s) filed on is/are: a)☐ accept	•					
Applicant may not request that any objection to the						
11) The proposed drawing correction filed on		approved by the Examiner.				
If approved, corrected drawings are required in rep						
12) The oath or declaration is objected to by the Ex	aminer.					
Priority under 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign	n priority under 35 U.S.C. §	119(a)-(d) or (f).				
a) ☐ All b) ☐ Some * c) ☐ None of:						
1. Certified copies of the priority documents have been received.						
2. Certified copies of the priority documents have been received in Application No						
<ul> <li>3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).</li> <li>* See the attached detailed Office action for a list of the certified copies not received.</li> </ul>						
14) Acknowledgment is made of a claim for domesti	c priority under 35 U.S.C. §	119(e) (to a provisional application).				
a)  The translation of the foreign language pro						
Attachment(s)	J					
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Inf	mmary (PTO-413) Paper No(s) ormal Patent Application (PTO-152)				

#### **DETAILED ACTION**

## Claim Objections

Claim 2 recites the limitation "the cover" in line 2. There is insufficient antecedent basis for this limitation in the claim.

## Claim Rejections - 35 USC § 103

- 1. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 2. Claims 1-4 and 16 are rejected under 35 U.S.C. 103(a) as being unpatentable over Gorowitz et al. (U.S. Pat. 5,757,072) in view of Noddin (U.S. Pat. 5731047).

Gorowitz et al. disclose the device (cover fig. and figs. 3a-3d, column 8, lines 20 et seq.) comprising:

an adhesive layer 30 to attach a Kapton polyimide film 32 (column 9, lines 18-24) to a dielectric film 28;

providing a cavity 16r, wherein the cavity is formed by etching and laser cutting (column 9, lines 15-24); therefore, the cavity having a smooth surface perimeter and extending through the Kapton polyimide film 32 and at least partially through the dielectric layer 28;

removing the film 32 (fig. 3b, column 9, lines 18-24);

attaching the semiconductor chip 12 to the dielectric layer 28 with an air bridge structure 12c being positioned with in the cavity. Gorowitz et al. disclose the claimed

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invention except not specifically pointing out the adhesive layer 30 is a partially-cured adhesive.

Noddin discloses a semiconductor device comprising: using a partially-cured adhesive (column 31, lines 10-15) and it is well known in the art to use the partially-cured adhesive to provide the secure bonding for the device. Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the device of Gorowitz et al. as shown by Noddin to provide the secure bonding for the device.

- Regarding claims 2 and 16, Gorowitz et al. disclose providing vias through the
  dielectric layer (figs. 3c-3d) extending to connection pads of the chip 12 and
  applying a pattern of electrical conductors to the connection pad (cover fig.).
- Regarding claim 3, Gorowitz et al. disclose using the adhesive to attach the Kapton polyimide film 32 to the package, coating the dielectric layer 28 with the adhesive 30.
- Regarding claim 4, Gorowitz et al. disclose attaching the chip comprises using the adhesive (fig. 3c, column 9, lines 25-37).
- 3. Claim 6 is rejected under 35 U.S.C. 103(a) as being unpatentable over Gorowitz et al. (U.S. Pat. 5,757,072) in view of Noddin (U.S. Pat. 5731047) and further in view of Arai et al. (JP. 02000047332).

Gorowitz et al. and Noddin fail to disclose the adhesive comprises a mixture of photodielectric and epoxy materials.

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Arai et al. disclose a semiconductor device comprising: an adhesive comprises a mixture of photopolymerizable and epoxy materials (abstract). Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the device of Gorowitz et al. and Noddin to provide a device with excellent adhesion property, as shown by Arai et al.

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4. Claims 7-8 are rejected under 35 U.S.C. 103(a) as being unpatentable over Gorowitz et al. (U.S. Pat. 5,757,072) in view of Noddin (U.S. Pat. 5731047) and further in view of Scherer (U.S. Pat. 4633573).

Gorowitz et al. and Noddin disclose the claimed invention except for not providing a protective coating in the cavity, and wherein the protective coating comprising a hermetic seal MEMS package flexible layer.

Scherer discloses a semiconductor device comprising:

a protective coating in a cavity, and wherein the protective coating comprising a hermetic seal for the package device (column 10, lines 4-7 and 22-26). Therefore, it would have been obvious to one having ordinary skill in the art at the time the invention was made to modify the device of Gorowitz et al. and Noddin to protect the microcircuit from the high temperatures required and to form a highly reliable, durable seal, while also insulating the microcircuit during the process of applying the non organic coating, as shown by Scherer.

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## Allowable Subject Matter

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Claim 19 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

#### Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to DiLinh Nguyen whose telephone number is (571) 272-1712. The examiner can normally be reached on 8:00AM - 6:00PM (M-F).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on (571) 272-1705. The fax phone numbers for the organization where this application or proceeding is assigned are (703) 308-7722 for regular communications and (703) 308-7724 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number in (703) 308-0956.

DLN January 5, 2004